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Docket No. 150.00640102

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Eugene P. Marsh

Group Art Unit:

Examiner:

2815

Serial No.:

09/942,200 Confirmation No.: 8194

J. Nguyen

Filed:

29 August 2001

For:

DIFFUSION BARRIER LAYERS AND METHODS OF FORMING SAME

## AMENDMENT AND RESPONSE

Assistant Commissioner for Patents Washington D.C. 20231

**FAX RECEIVED** 

JAN 2 1 2003

Dear Sir:

**TECHNOLOGY CENTER 2800** 

In response to the Office Action dated 22 August 2002, please amend the aboveidentified application as follows:

## In the Specification

Please replace the paragraph beginning at page 11, line 6, with the following rewritten paragraph. Per 37 C.F.R. § 1.121, this paragraph is also shown in Appendix A with notations to indicate the changes made.

Methods of forming the co-deposited platinum:ruthenium alloy layer 14 are described in co-pending patent application entitled "Method for Producing Low Carbon/Oxygen Conductive Layers" having U.S. Serial No. 09/146,297, filed September 3, 1998, and issued as U.S. Patent No. 6,284,655 B1. For example, one such method includes forming a substantially carbon- and oxygen-free conductive layer in an oxidizing atmosphere in the presence of an organometallic catalyst using a chemical vapor deposition process. One skilled in the art will recognize that these methods and various other methods may be used to form the platinum:ruthenium alloy layer 14 according to the present invention.